

## APPLICATION DATA SHEET

**Application Information**

|                                  |  |
|----------------------------------|--|
| Application Type::               | Regular  |
| Subject Matter::                 | Utility  |
| Title::                          | SEMICONDUCTOR SUBSTRATE,<br>SEMICONDUCTOR DEVICE AND PROCESS<br>FOR PRODUCING SEMICONDUCTOR<br>SUBSTRATE |
| Attorney Docket No::             | 60562.00009  |
| Total Drawing Sheets::           | 19   |
| Request for Early Publication?:: | No   |
| Request for Non-Publication?::   | No   |
| Small Entity::                   | Yes  |
| Secrecy Order in Parent Appln?:: | No   |

**Applicant Information**

|                                  |   |
|----------------------------------|---|
| Applicant Authority Type::       | Inventor  |
| Citizenship Country::            | Japan   |
| Status::                         | Full Capacity   |
| Given Name::                     | Tetsushi  |
| Middle Name::                    |   |
| Family Name::                    | SAKAI   |
| City of Residence::              | Yokohama  |
| State or Province of Residence:: |   |
| Country of Residence::           | Japan   |
| Street of Mailing Address::      | c/o Tokyo Institute of Technology<br>4259, Nagatsuta-cho, Midori-ku |

City of Mailing Address:: Yokohama-shi  
State or Province of Mailing Address:: Kanagawa  
Country of Mailing Address:: Japan  
Postal or Zip Code of Mailing Address:: 226-8503

Applicant Authority Type:: Inventor  
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Status:: Full Capacity  
Given Name:: Shunichiro  
Middle Name::  
Family Name:: OHMI  
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Country of Residence:: Japan  
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City of Mailing Address:: Yokohama-shi  
State or Province of Mailing Address:: Kanagawa  
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Applicant Authority Type:: Inventor  
Citizenship Country:: Japan  
Status:: Full Capacity  
Given Name:: Takashi  
Middle Name::  
Family Name:: YAMAZAKI  
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State or Province of Residence::  
Country of Residence:: Japan

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Postal or Zip Code of Mailing Address:: 2268503

**Correspondence Information**

Correspondence Customer Number:: 32294

**Representative Information**

Representative Customer Number:: 32294

**Domestic Priority Information**

| Application::    | Continuity Type:: | Parent Application:: | Parent Filing Date:: |
|------------------|-------------------|----------------------|----------------------|
| This Application | National Stage of | PCT/JP2004/014603    | 10/04/04             |
|                  |                   |                      |                      |
|                  |                   |                      |                      |

**Foreign Priority Information**

Country:: Japan  
Application No:: 2003-352692  
Filing Date:: 10/10/03  
Priority Claimed:: Yes

**Assignment Information**

Assignee Name::

TOKYO INSTITUTE OF TECHNOLOGY